

SKKT 27, SKKT 27B, SKKH 27



SEMIPACK® 1

Thyristor / Diode Modules

SKKT 27
SKKT 27B
SKKH 27

Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

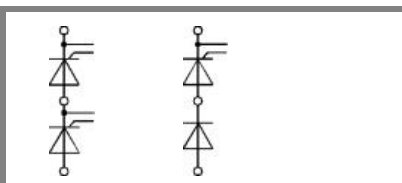
Typical Applications*

- DC motor control (e. g. for machine tools)
- AC motor soft starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

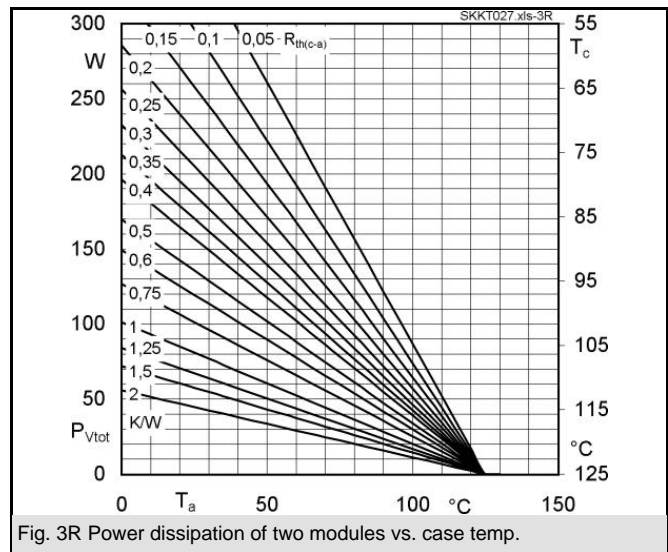
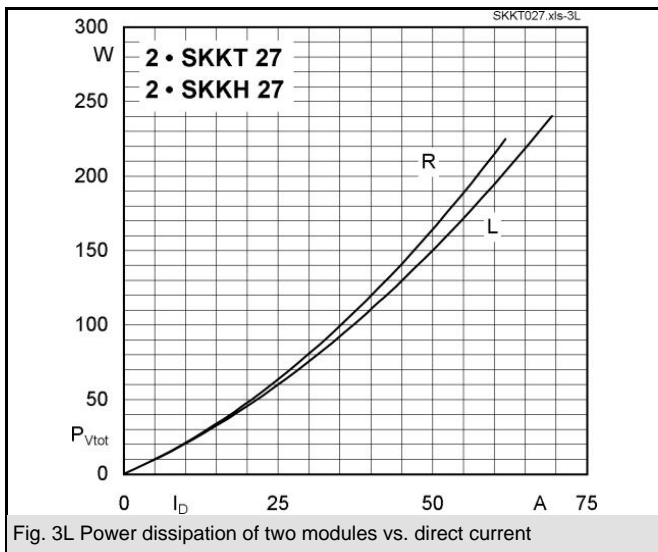
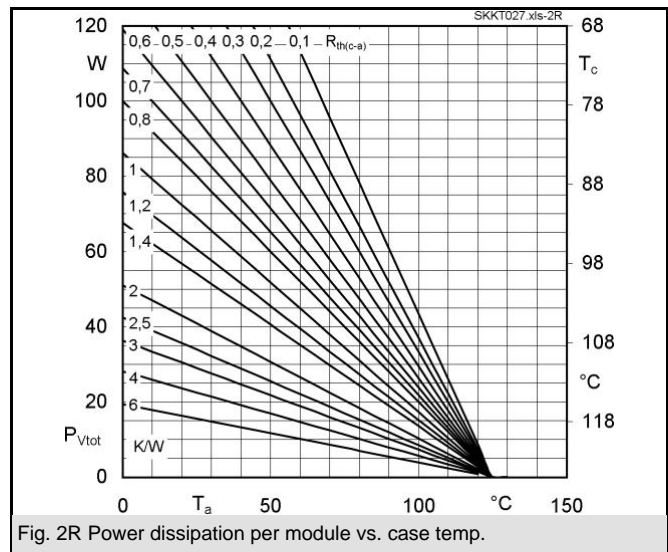
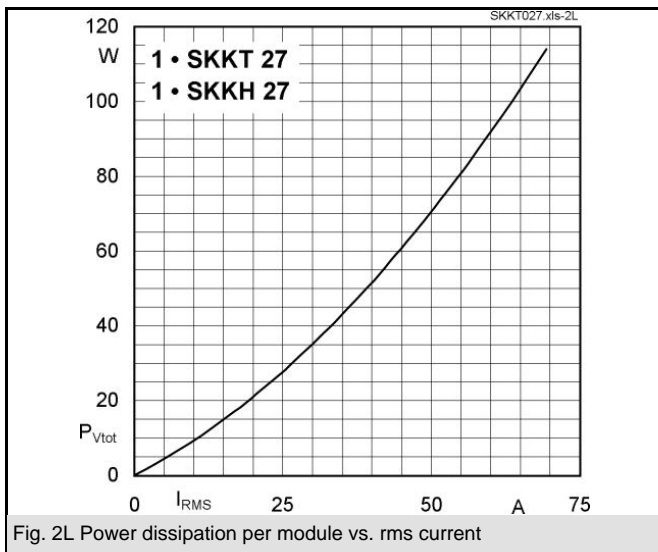
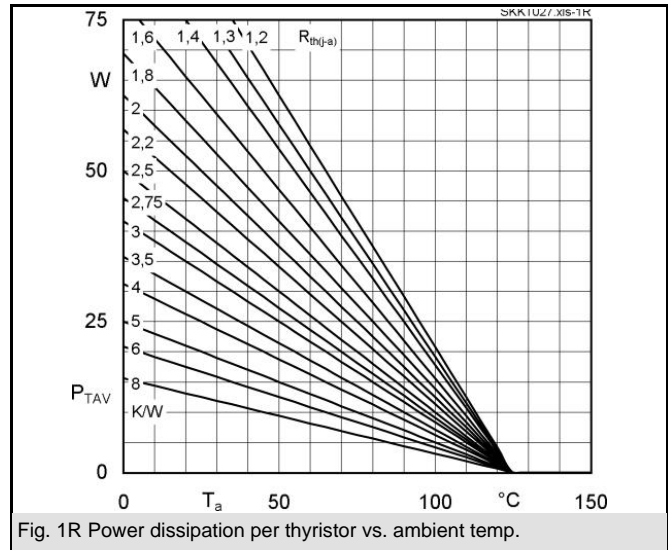
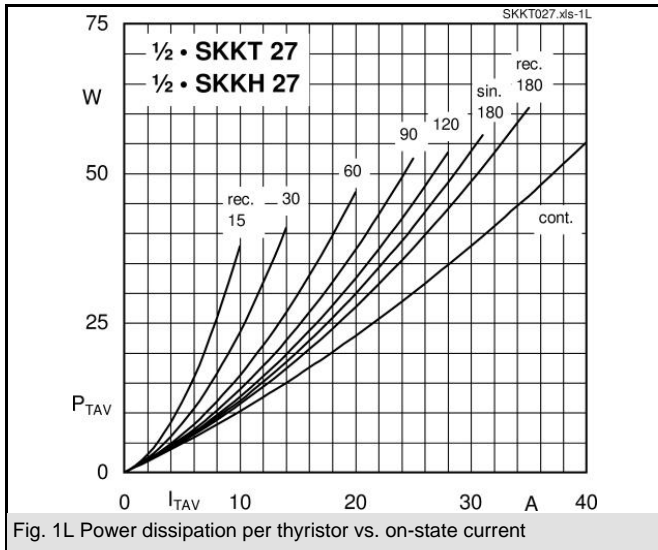
1) See the assembly instructions

| V_{RSM} V | V_{RRM}, V_{DRM} V | $I_{TRMS} = 50$ A (maximum value for continuous operation) $I_{TAV} = 27$ A (sin. 180; $T_c = 82$ °C) | | |
|----------------|-------------------------|--|-------------|-------------|
| 900 | 800 | SKKT 27/08E | SKKT 27B08E | SKKH 27/08E |
| 1300 | 1200 | SKKT 27/12E | SKKT 27B12E | SKKH 27/12E |
| 1500 | 1400 | SKKT 27/14E | SKKT 27B14E | SKKH 27/14E |
| 1700 | 1600 | SKKT 27/16E | SKKT 27B16E | SKKH 27/16E |
| 1900 | 1800 | | | SKKH 27/18E |

| Symbol | Conditions | Values | Units |
|------------------|---|------------------------|------------------|
| I_{TAV} | sin. 180; $T_c = 85$ (100) °C; | 25 (18) | A |
| I_D | P3/180; $T_a = 45$ °C; B2 / B6 P3/180F; $T_a = 35$ °C; B2 / B6 | 38 / 50 60 / 77 | A |
| I_{RMS} | P3/180; $T_a = 45$ °C; W1 / W3 | 52 / 3 x 37 | A |
| I_{TSM} | $T_{vj} = 25$ °C; 10 ms $T_{vj} = 125$ °C; 10 ms | 550 480 | A |
| i^2t | $T_{vj} = 25$ °C; 8,3 ... 10 ms $T_{vj} = 125$ °C; 8,3 ... 10 ms | 1500 1150 | A ² s |
| V_T | $T_{vj} = 25$ °C; $I_T = 75$ A | max. 1,8 | V |
| $V_{T(TO)}$ | $T_{vj} = 125$ °C | max. 0,9 | V |
| r_T | $T_{vj} = 125$ °C | max. 12 | mΩ |
| I_{DD}, I_{RD} | $T_{vj} = 125$ °C; $V_{RD} = V_{RRM}; V_{DD} = V_{DRM}$ | max. 10 | mA |
| t_{gd} | $T_{vj} = 25$ °C; $I_G = 1$ A; $di_G/dt = 1$ A/μs | 1 | μs |
| t_{gr} | $V_D = 0,67 * V_{DRM}$ | 1 | μs |
| $(di/dt)_{cr}$ | $T_{vj} = 125$ °C | max. 150 | A/μs |
| $(dv/dt)_{cr}$ | $T_{vj} = 125$ °C | max. 1000 | V/μs |
| t_q | $T_{vj} = 125$ °C | 80 | μs |
| I_H | $T_{vj} = 25$ °C; typ. / max. | 100 / 200 | mA |
| I_L | $T_{vj} = 25$ °C; $R_G = 33$ Ω; typ. / max. | 250 / 400 | mA |
| V_{GT} | $T_{vj} = 25$ °C; d.c. | min. 3 | V |
| I_{GT} | $T_{vj} = 25$ °C; d.c. | min. 150 | mA |
| V_{GD} | $T_{vj} = 125$ °C; d.c. | max. 0,25 | V |
| I_{GD} | $T_{vj} = 125$ °C; d.c. | max. 5 | mA |
| $R_{th(j-c)}$ | cont.; per thyristor / per module | 0,9 / 0,45 | K/W |
| $R_{th(j-c)}$ | sin. 180; per thyristor / per module | 0,95 / 0,48 | K/W |
| $R_{th(j-c)}$ | rec. 120; per thyristor / per module | 1 / 0,5 | K/W |
| $R_{th(c-s)}$ | per thyristor / per module | 0,2 / 0,1 | K/W |
| T_{vj} | | - 40 ... + 125 | °C |
| T_{stg} | | - 40 ... + 125 | °C |
| V_{isol} | a. c. 50 Hz; r.m.s.; 1 s / 1 min. to heatsink | 3600 / 3000 | V~ |
| M_s | to terminals | 5 ± 15 % ¹⁾ | Nm |
| M_t | | 3 ± 15 % | Nm |
| a | | 5 * 9,81 | m/s ² |
| m | approx. | 95 | g |
| Case | SKKT | A 46 | |
| | SKKT ...B | A 48 | |
| | SKKH | A 47 | |



SKKT **SKKH**



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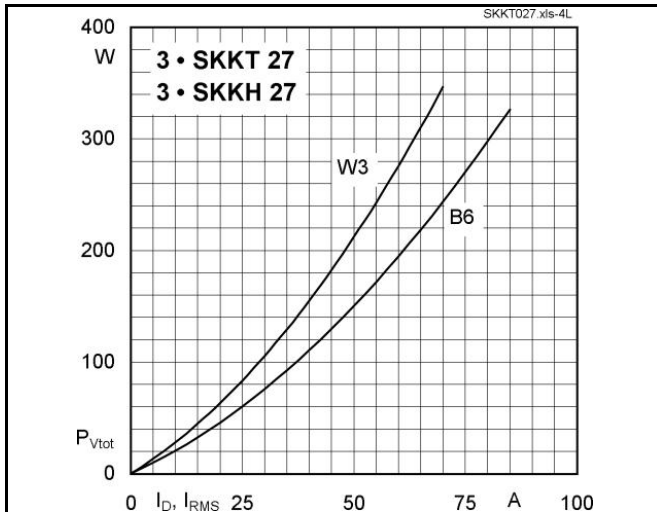


Fig. 4L Power dissipation of three modules vs. direct and rms current

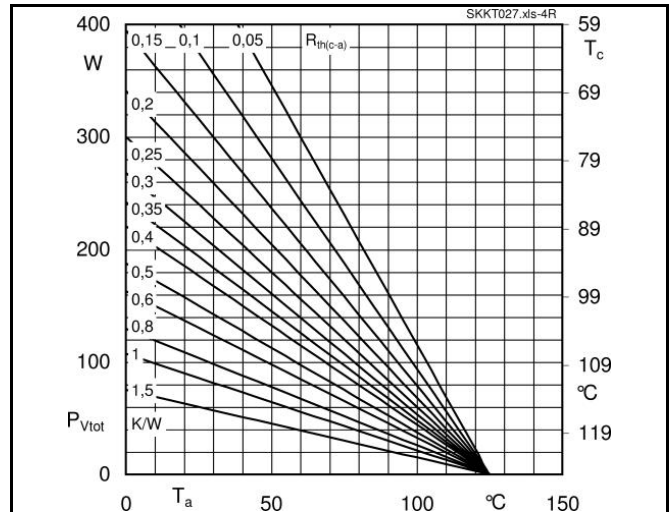


Fig. 4R Power dissipation of three modules vs. case temp.

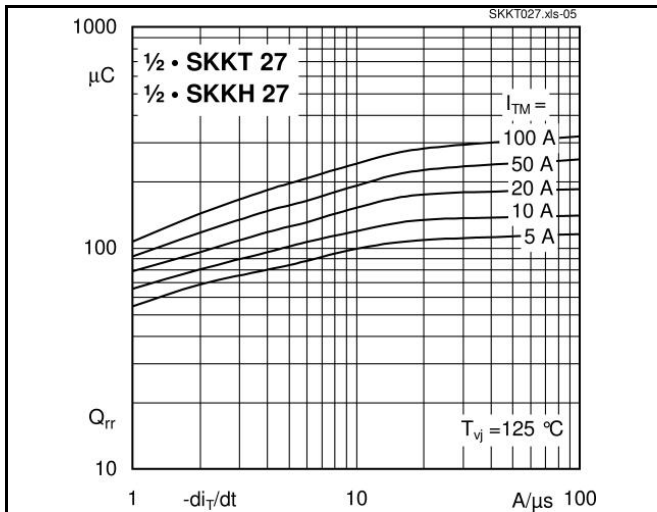


Fig. 5 Recovered charge vs. current decrease

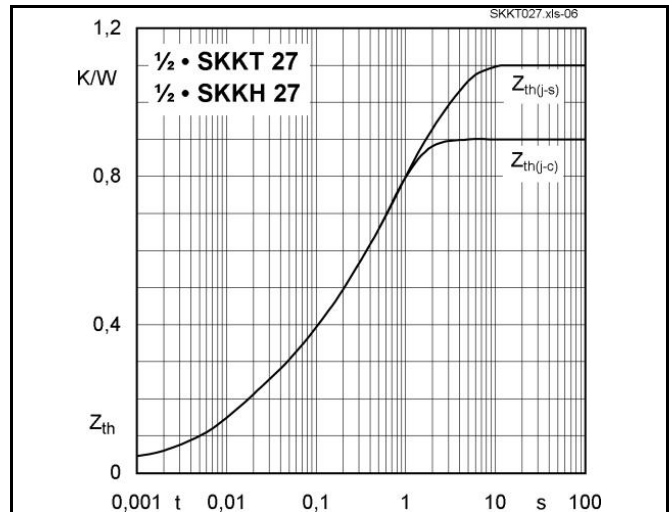


Fig. 6 Transient thermal impedance vs. time

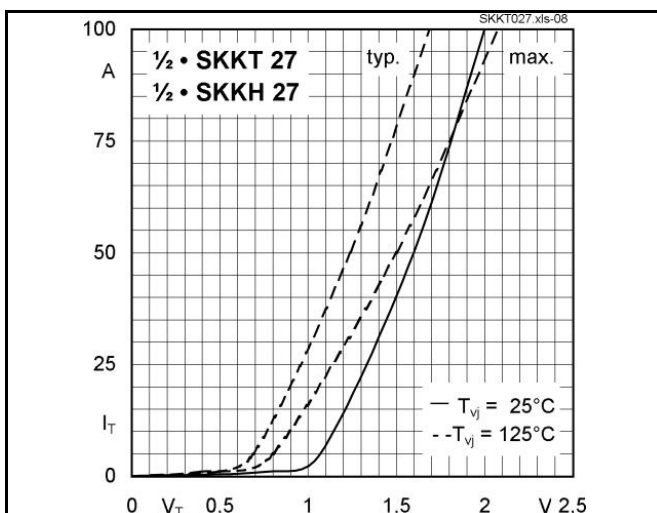


Fig. 7 On-state characteristics

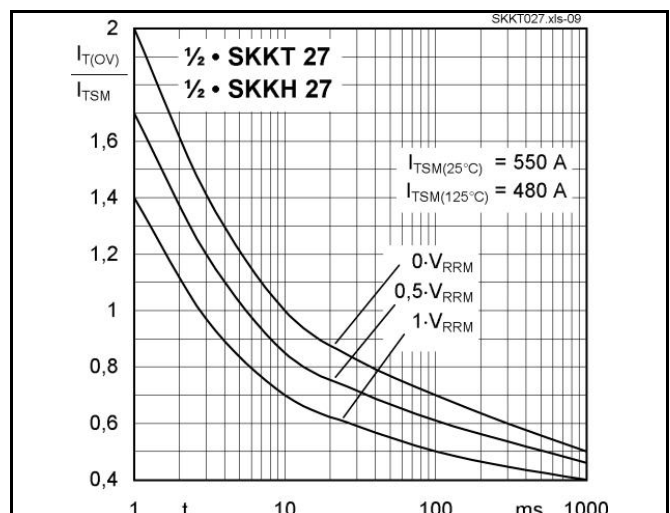


Fig. 8 Surge overload current vs. time

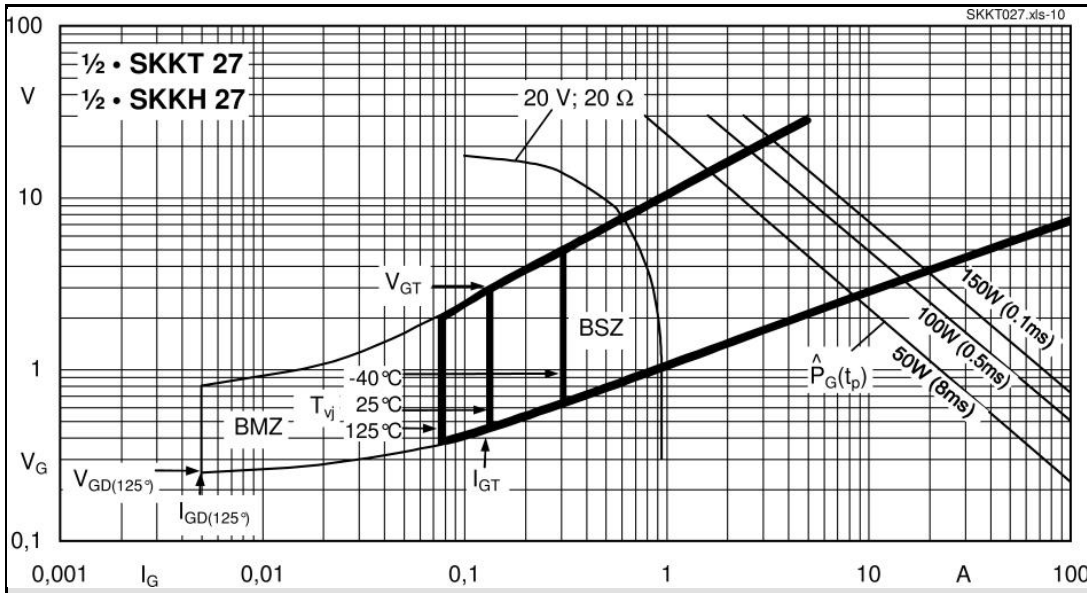
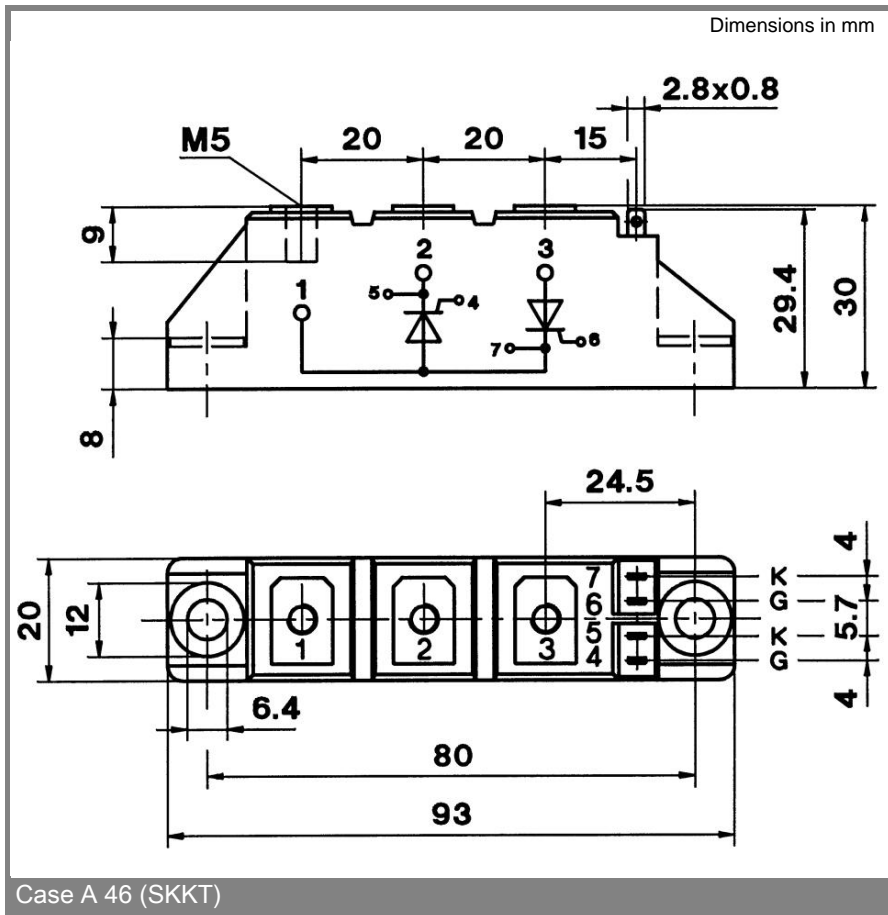
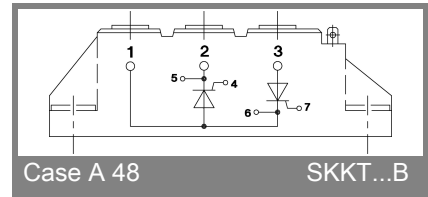


Fig. 9 Gate trigger characteristics

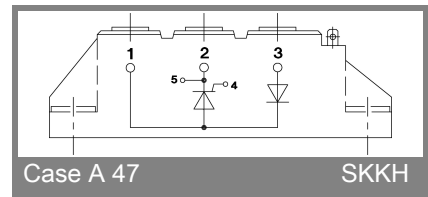


Case A 46 (SKKT)



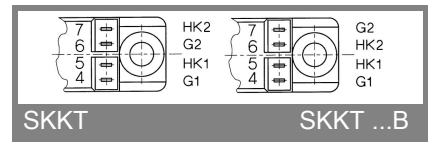
Case A 48

SKKT...B



Case A 47

SKKH



SKKT

SKKT...B

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.